

## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>SEMICONDUCTOR PROCESS AND YIELD ANALYSIS INTEGRATED REAL-TIME MANAGEMENT METHOD</b>
<p>Application Number :</p> <p>Date :</p> <p>First Named Applicant: Hung-En Tai</p> <p>Confirmation Number:</p> <p>Attorney Docket Number: LKSP0045USA</p>	
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<p>Submitted By:</p> <p>Winston Hsu</p> <p>Registered Number: 41,526</p>	<p>Elec. Sign.</p> <p>Winston Hsu</p>

Documents being submitted:	Files
us-fee-sheet	LKSP0045-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-declaration	LKSP0045-usdecl.xml us-declaration.dtd us-declaration.xsl
us-power-of-attorney-grant	LKSP0045-uspoat.xml us-power-of-attorney-grant.dtd us-power-of-attorney-grant.xsl
us-assignment	LKSP0045-usassn.xml us-assignment.xsl us-assignment.dtd LKSP0045ASS1.tif LKSP0045ASS2.tif
us-request	LKSP0045-usrequ.xml us-request.dtd us-request.xsl
application-body	LKSP0045-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd lksp0045usa-01.tif lksp0045usa-02.tif lksp0045usa-03.tif lksp0045usa-04.tif

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	lksp0045usa-09.tif
	lksp0045usa-10.tif
us-declaration	LKSP0045DEC1.tif
us-declaration	LKSP0045DEC2.tif
<b>Comments</b>	